

EU Declaration of Conformity (DoC)

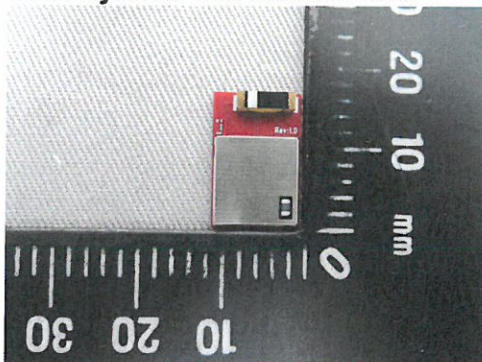
We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

Product Type:	RF Module
Model Number(s):	CC2650MODA
Trademark	Texas Instruments Incorporated

The object of the declaration:



is in conformity with the relevant Union harmonization legislation:

Radio Equipment Directive (RED), 2014/53/EU
RoHS2 Directive, 2011/65/EC

The following harmonized standards and technical specifications have been applied:

EN 55024:2010+A1:2015
EN 55032:2015+AC:2016-07
EN 50581:2012
EN 60950-1:2006+A11:2009+A1:2010+A12:2011+A2:2013
EN 62479:2010
EN 300 328 V2.1.1 (2016-11)
Draft EN 301 489-1 V2.2.0 (2017-03)
Draft EN 301 489-17 V3.2.0 (2017-03)

Notified Body:

Notified Body:	SGS Fimko Ltd.
Notified Body Number	0589
Reference number of the certificate of notified body	Certificate RED-1079 HEL-CERT170600267-01

Technical Compliance File Held by:

Texas Instruments Incorporated
13121 TI Boulevard, MS 368
Dallas, Texas 75243 USA



Signed for and on behalf of Texas Instruments Incorporated

Name:	Jan Bjørnar Lund, Product Line Manager, SCS
Address:	Post Office Box 660199, Dallas, Texas 75266-0199

<u>Oslo</u>	<u>6/22-17</u>	<u>Jan Bjørnar Lund</u>
Place of issue	Date of issue	Signature of Authorized Person

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